

Procedure file

Basic information	
DEA - Delegated acts procedure	2013/2918(DEA)
Exemption for lead in solders, termination coatings of electrical and electronic components and printed circuit boards, connections of electrical wires, shields and enclosed connectors	Procedure completed - delegated act enters into force
Supplementing 2008/0240(COD)	
Subject 3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)	

Technical information	
Procedure reference	2013/2918(DEA)
Procedure type	DEA - Delegated acts procedure
Procedure subtype	Examination of delegated act
Stage reached in procedure	Procedure completed - delegated act enters into force
Committee dossier	ENVI/7/14385